



# SGM8603

## 1.1mA, 11MHz, Low Noise, Rail-to-Rail I/O Tiny Package, CMOS Operational Amplifier

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### GENERAL DESCRIPTION

The SGM8603 (single with shutdown) is a low noise, low voltage and low power operational amplifier that can be designed into a wide range of applications. The SGM8603 has a high gain-bandwidth product of 11MHz, a slew rate of 8.5V/ $\mu$ s, and a quiescent current of 1.1mA at 5V. The SGM8603 has a power-down disable feature that reduces the supply current to less than 1 $\mu$ A.

The SGM8603 is designed to provide optimal performance in low voltage and low noise systems. It provides rail-to-rail output swing into heavy loads. The input common mode voltage range includes ground, and the maximum input offset voltage is 4.9mV for SGM8603. The operating supply range is from 2.1V to 5.5V.

The SGM8603 is available in Green TDFN-2 $\times$ 2-6L package. It is specified over the extended industrial temperature range (-40 $^{\circ}$ C to +125 $^{\circ}$ C).

### FEATURES

- **Rail-to-Rail Input and Output**  
1.1mV Typical  $V_{OS}$
- **High Gain-Bandwidth Product: 11MHz**
- **High Slew Rate: 8.5V/ $\mu$ s**
- **Settling Time to 0.1% with 2V Step: 0.21 $\mu$ s**
- **Overload Recovery Time: 0.6 $\mu$ s**
- **Low Noise: 8.5nV/ $\sqrt{\text{Hz}}$  at 10kHz**
- **Supply Voltage Range: 2.1V to 5.5V**
- **Input Common Mode Voltage Range:**  
-0.1V to +5.6V with  $V_S = 5.5V$
- **Low Power**  
1.1mA Typical Supply Current  
Less than 1 $\mu$ A when Disabled
- **-40 $^{\circ}$ C to +125 $^{\circ}$ C Operating Temperature Range**
- **Available in Green TDFN-2 $\times$ 2-6L Package**

### APPLICATIONS

Sensors  
Audio  
Active Filters  
A/D Converters  
Communications  
Test Equipment  
Cellular and Cordless Phones  
Laptops and PDAs  
Photodiode Amplification  
Battery-Powered Instrumentation

**PACKAGE/ORDERING INFORMATION**

MODEL	PACKAGE DESCRIPTION	SPECIFIED TEMPERATURE RANGE	ORDERING NUMBER	PACKAGE MARKING	PACKING OPTION
SGM8603	TDFN-2x2-6L	-40°C to +125°C	SGM8603XTDI6G/TR	8603 XXXX	Tape and Reel, 3000

NOTE: XXXX = Date Code.

Green (RoHS & HSF): SG Micro Corp defines "Green" to mean Pb-Free (RoHS compatible) and free of halogen substances. If you have additional comments or questions, please contact your SGMICRO representative directly.

**ABSOLUTE MAXIMUM RATINGS**

Supply Voltage, +V<sub>S</sub> to -V<sub>S</sub> ..... 6V  
 Input Common Mode Voltage Range  
 .....(-V<sub>S</sub>) - 0.3V to (+V<sub>S</sub>) + 0.3V  
 Storage Temperature Range ..... -65°C to +150°C  
 Junction Temperature ..... 150°C  
 Lead Temperature (Soldering 10sec) ..... 260°C  
 ESD Susceptibility  
 HBM..... 4000V  
 MM..... 400V  
 CDM ..... 1000V

**RECOMMENDED OPERATING CONDITIONS**

Input Voltage Range ..... 2.1V to 5.5V  
 Operating Temperature Range ..... -40°C to +125°C

**DISCLAIMER**

SG Micro Corp reserves the right to make any change in circuit design, specification or other related things if necessary without notice at any time.

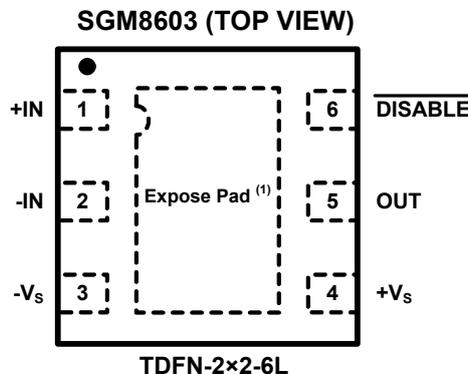
**OVERSTRESS CAUTION**

Stresses beyond those listed may cause permanent damage to the device. Functional operation of the device at these or any other conditions beyond those indicated in the operational section of the specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

**ESD SENSITIVITY CAUTION**

This integrated circuit can be damaged by ESD if you don't pay attention to ESD protection. SGMICRO recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage. ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

**PIN CONFIGURATION**



NOTE 1: Exposed pad can be connected to -V<sub>S</sub> or left floating.

**ELECTRICAL CHARACTERISTICS**(At  $T_A = +25^\circ\text{C}$ ,  $V_S = +5\text{V}$ ,  $V_{CM} = V_S/2$ ,  $R_L = 600\Omega$ , unless otherwise noted.)

PARAMETER	CONDITIONS	SGM8603						
		TYP	MIN/MAX OVER TEMPERATURE				UNITS	MIN/MAX
		+25°C	+25°C	-40°C to 85°C	-40°C to 125°C			
<b>INPUT CHARACTERISTICS</b>								
Input Offset Voltage ( $V_{OS}$ )		1.1	4.9	5.1	5.4	mV	MAX	
Input Bias Current ( $I_B$ )		1				pA	TYP	
Input Offset Current ( $I_{OS}$ )		1				pA	TYP	
Input Common Mode Voltage Range ( $V_{CM}$ )	$V_S = 5.5\text{V}$	-0.1 to +5.6				V	TYP	
Common Mode Rejection Ratio (CMRR)	$V_S = 5.5\text{V}, V_{CM} = -0.1\text{V to } 4\text{V}$	83	67	66	65	dB	MIN	
	$V_S = 5.5\text{V}, V_{CM} = -0.1\text{V to } 5.6\text{V}$	77	61	60	56	dB	MIN	
Open-Loop Voltage Gain ( $A_{OL}$ )	$R_L = 600\Omega, V_O = 0.15\text{V to } 4.85\text{V}$	91	85	73	62	dB	MIN	
	$R_L = 10\text{k}\Omega, V_O = 0.05\text{V to } 4.95\text{V}$	105	97	84	69	dB	MIN	
Input Offset Voltage Drift ( $\Delta V_{OS}/\Delta T$ )		2.7				$\mu\text{V}/^\circ\text{C}$	TYP	
<b>OUTPUT CHARACTERISTICS</b>								
Output Voltage Swing from Rail	$R_L = 600\Omega$	78	102	123	144	mV	MAX	
	$R_L = 10\text{k}\Omega$	7	12	14	20	mV	MAX	
Output Current ( $I_{OUT}$ )		64	52	25	19	mA	MIN	
Closed-Loop Output Impedance	$f = 1\text{MHz}, G = 1$	8.5				$\Omega$	TYP	
<b>POWER-DOWN DISABLE</b>								
Turn-On Time		1.1				$\mu\text{s}$	TYP	
Turn-Off Time		0.3				$\mu\text{s}$	TYP	
DISABLE Voltage-Off			0.8			V	MAX	
DISABLE Voltage-On			2			V	MIN	
<b>POWER SUPPLY</b>								
Operating Voltage Range			2.1	2.1	2.1	V	MIN	
			5.5	5.5	5.5	V	MAX	
Power Supply Rejection Ratio (PSRR)	$V_S = +2.1\text{V to } +5.5\text{V}, V_{CM} = (-V_S) + 0.5\text{V}$	80	68	67	64	dB	MIN	
Quiescent Current ( $I_Q$ )	$I_{OUT} = 0$	1.1	1.4	1.6	1.75	mA	MAX	
Supply Current when Disabled		0.5	8	9	10	$\mu\text{A}$	MAX	
<b>DYNAMIC PERFORMANCE</b>								
Gain-Bandwidth Product (GBP)	$R_L = 10\text{k}\Omega$	11				MHz	TYP	
Phase Margin ( $\phi_O$ )		62				$^\circ$	TYP	
Full Power Bandwidth ( $BW_P$ )	< 1% distortion	400				kHz	TYP	
Slew Rate (SR)	$G = 1, 2\text{V output step}$	8.5				$\text{V}/\mu\text{s}$	TYP	
Settling Time to 0.1% ( $t_S$ )	$G = 1, 2\text{V output step}$	0.21				$\mu\text{s}$	TYP	
Overload Recovery Time	$V_{IN} \times \text{Gain} = V_S$	0.6				$\mu\text{s}$	TYP	
<b>NOISE PERFORMANCE</b>								
Voltage Noise Density ( $e_n$ )	$f = 1\text{kHz}$	12.5				$\text{nV}/\sqrt{\text{Hz}}$	TYP	
	$f = 10\text{kHz}$	8.5				$\text{nV}/\sqrt{\text{Hz}}$	TYP	

# 1.1mA, 11MHz, Low Noise, Rail-to-Rail I/O SGM8603 Tiny Package, CMOS Operational Amplifier

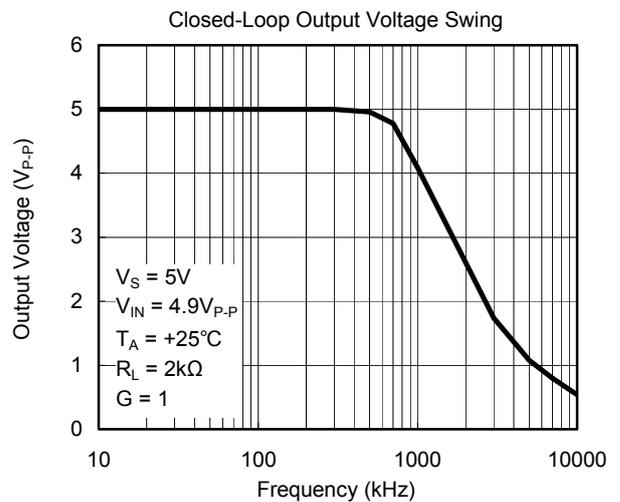
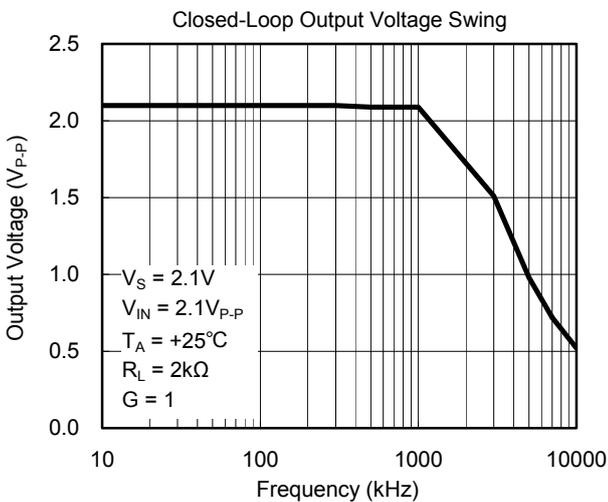
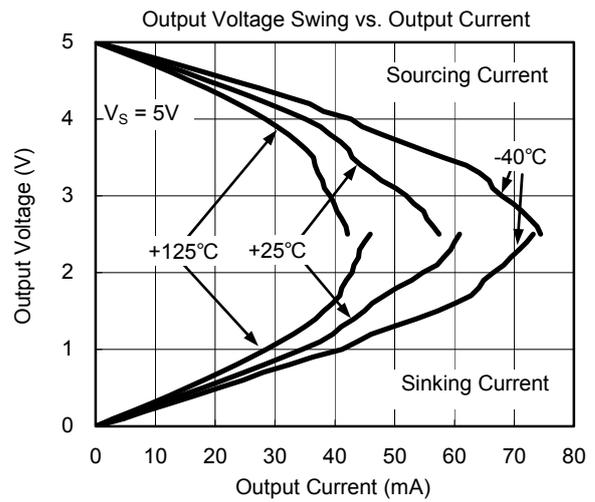
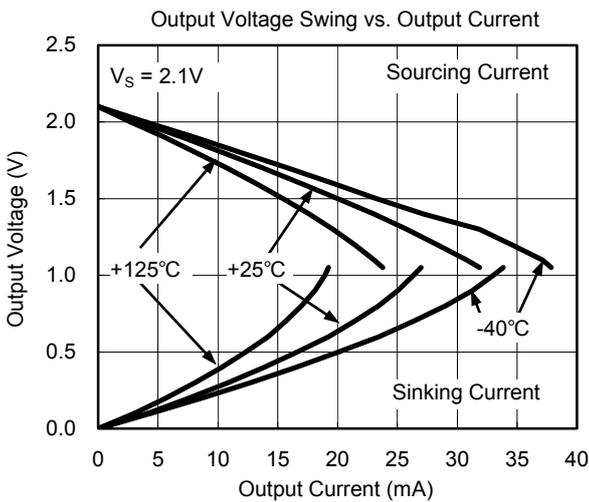
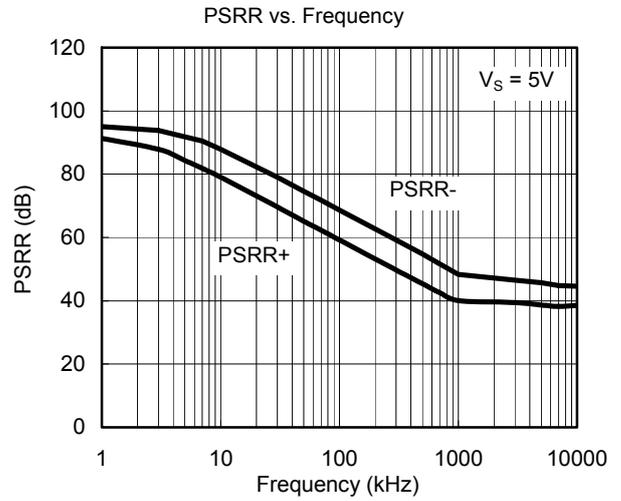
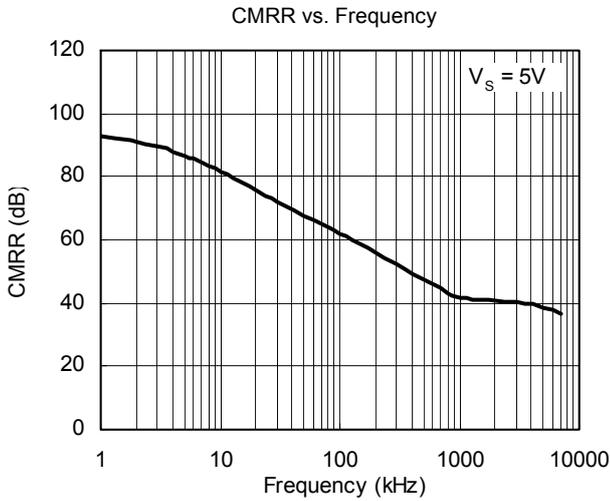
## ELECTRICAL CHARACTERISTICS

(At  $T_A = +25^\circ\text{C}$ ,  $V_S = +2.1\text{V}$ ,  $V_{CM} = V_S/2$ ,  $R_L = 600\Omega$ , unless otherwise noted.)

PARAMETER	CONDITIONS	SGM8603						
		TYP	MIN/MAX OVER TEMPERATURE				UNITS	MIN/MAX
		+25°C	+25°C	-40°C to 85°C	-40°C to 125°C			
<b>INPUT CHARACTERISTICS</b>								
Input Offset Voltage ( $V_{OS}$ )		1	5.2	5.5	5.6	mV	MAX	
Input Bias Current ( $I_B$ )		1				pA	TYP	
Input Offset Current ( $I_{OS}$ )		1				pA	TYP	
Input Common Mode Voltage Range ( $V_{CM}$ )	$V_S = 2.1\text{V}$	-0.1 to +2.2				V	TYP	
Common Mode Rejection Ratio (CMRR)	$V_S = 2.1\text{V}, V_{CM} = -0.1\text{V to }0.6\text{V}$	77	60	59	51	dB	MIN	
	$V_S = 2.1\text{V}, V_{CM} = -0.1\text{V to }2.2\text{V}$	70	55	53	49	dB	MIN	
Open-Loop Voltage Gain ( $A_{OL}$ )	$R_L = 600\Omega, V_O = 0.15\text{V to }1.95\text{V}$	88	78	68	58	dB	MIN	
	$R_L = 10\text{k}\Omega, V_O = 0.05\text{V to }2.05\text{V}$	100	89	82	67	dB	MIN	
Input Offset Voltage Drift ( $\Delta V_{OS}/\Delta T$ )		2.9				$\mu\text{V}/^\circ\text{C}$	TYP	
<b>OUTPUT CHARACTERISTICS</b>								
Output Voltage Swing from Rail	$R_L = 600\Omega$	38	50	59	66	mV	MAX	
	$R_L = 10\text{k}\Omega$	4	9	11	12	mV	MAX	
Output Current ( $I_{OUT}$ )		28	23	17	14	mA	MIN	
Closed-Loop Output Impedance	$f = 1\text{MHz}, G = 1$	9.3				$\Omega$	TYP	
<b>POWER-DOWN DISABLE</b>								
Turn-On Time		7.7				$\mu\text{s}$	TYP	
Turn-Off Time		0.5				$\mu\text{s}$	TYP	
DISABLE Voltage-Off			0.4			V	MAX	
DISABLE Voltage-On			1.8			V	MIN	
<b>POWER SUPPLY</b>								
Quiescent Current ( $I_Q$ )	$I_{OUT} = 0$	1.1	1.4	1.6	1.75	mA	MAX	
Supply Current when Disabled		0.5	8	9	10	$\mu\text{A}$	MAX	
<b>DYNAMIC PERFORMANCE</b>								
Gain-Bandwidth Product (GBP)	$R_L = 10\text{k}\Omega$	11.5				MHz	TYP	
Phase Margin ( $\phi_O$ )		59				$^\circ$	TYP	
Full Power Bandwidth ( $BW_P$ )	< 1% distortion	400				kHz	TYP	
Slew Rate (SR)	$G = 1, 2\text{V}$ output step	8				$\text{V}/\mu\text{s}$	TYP	
Settling Time to 0.1% ( $t_S$ )	$G = 1, 2\text{V}$ output step	0.23				$\mu\text{s}$	TYP	
Overload Recovery Time	$V_{IN} \times \text{Gain} = V_S$	1				$\mu\text{s}$	TYP	
<b>NOISE PERFORMANCE</b>								
Voltage Noise Density ( $e_n$ )	$f = 1\text{kHz}$	15				$\text{nV}/\sqrt{\text{Hz}}$	TYP	
	$f = 10\text{kHz}$	9				$\text{nV}/\sqrt{\text{Hz}}$	TYP	

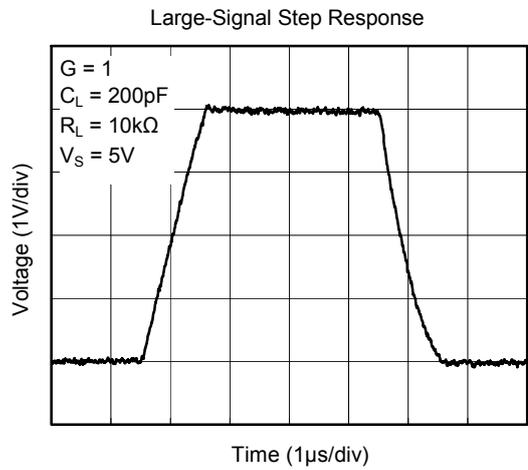
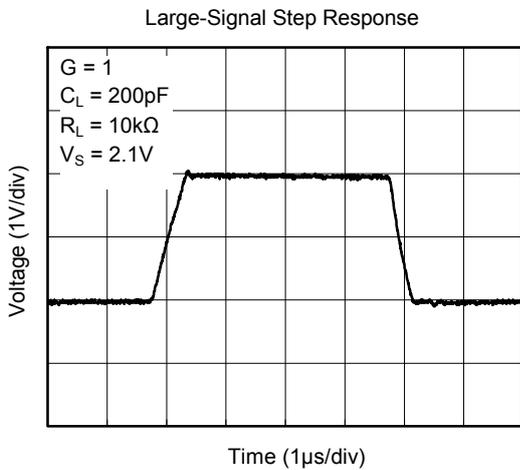
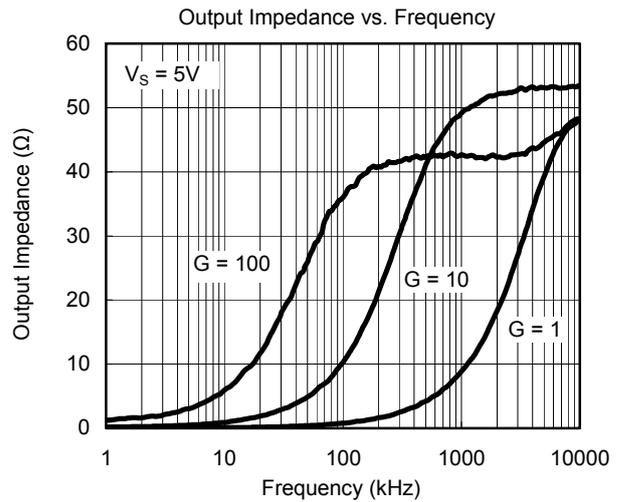
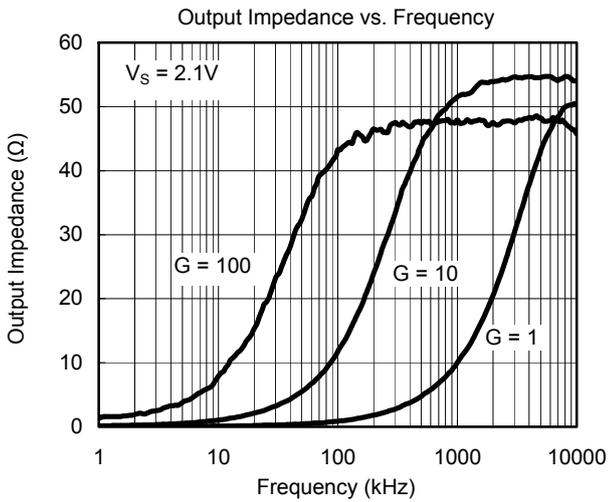
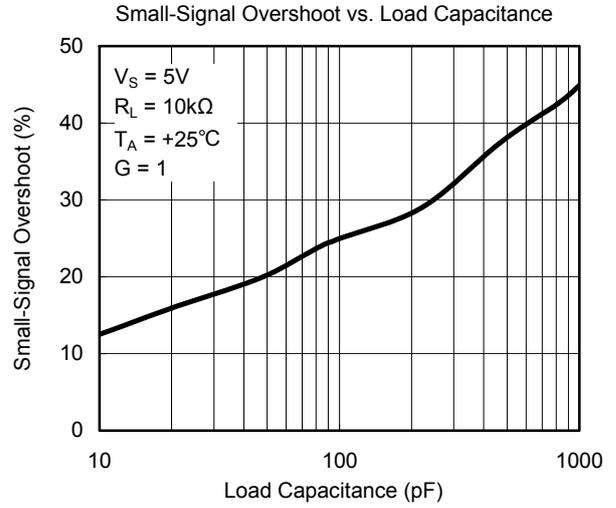
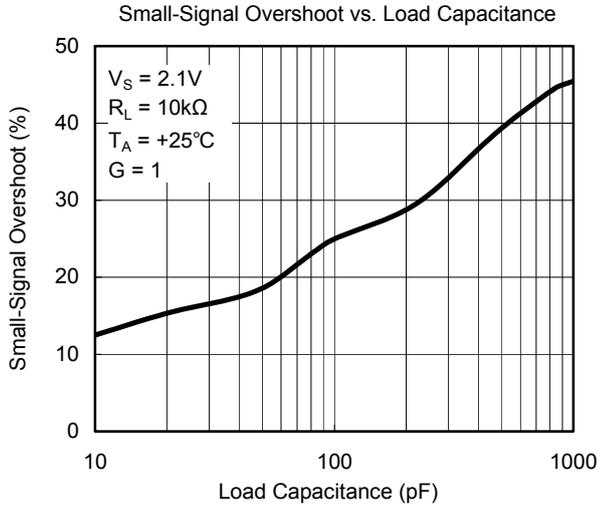
**TYPICAL PERFORMANCE CHARACTERISTICS**

At  $T_A = +25^\circ\text{C}$ ,  $V_{CM} = V_S/2$ ,  $R_L = 600\Omega$ , unless otherwise noted.



**TYPICAL PERFORMANCE CHARACTERISTICS**

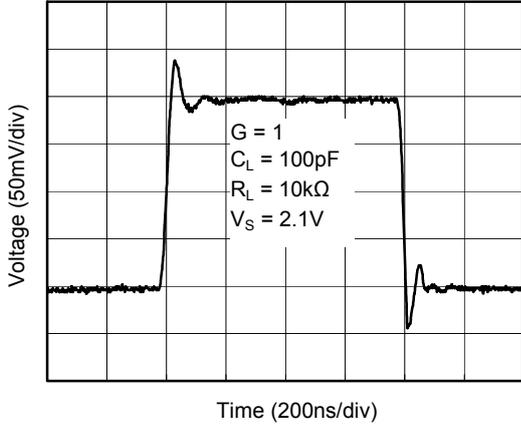
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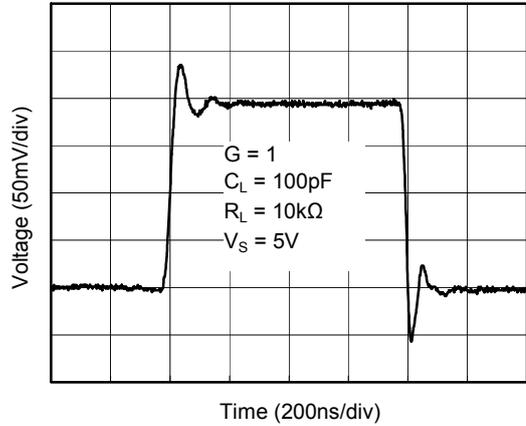
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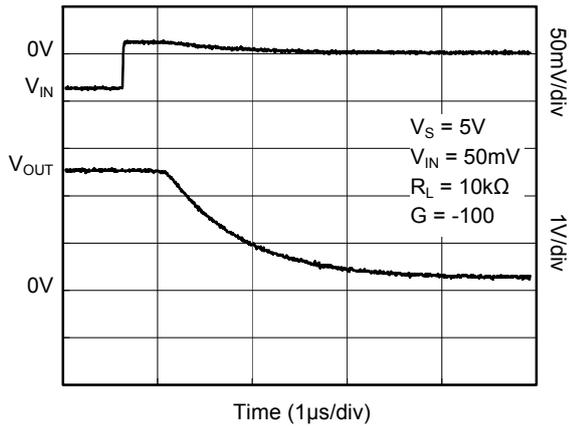
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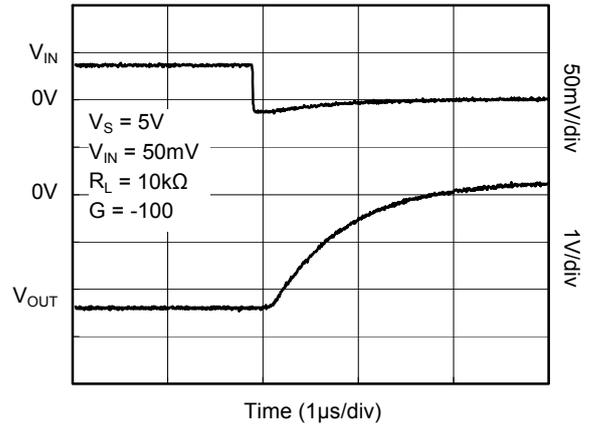
Small-Signal Step Response



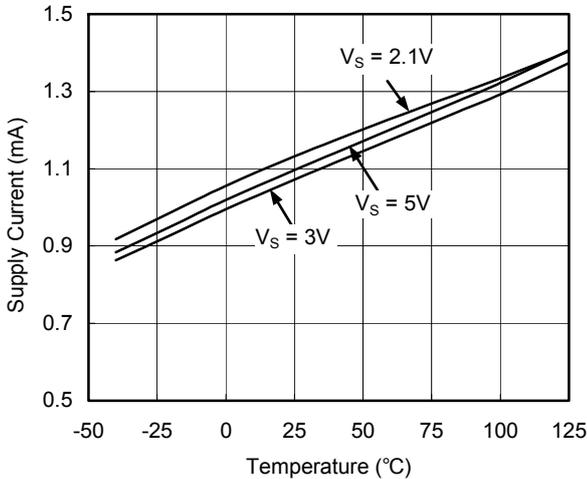
Positive Overload Recovery



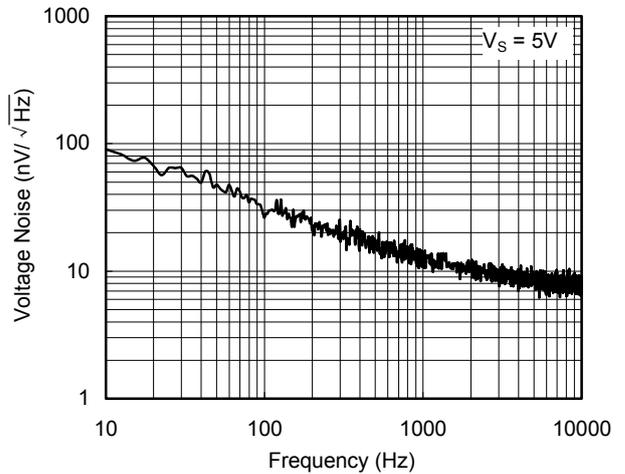
Negative Overload Recovery



Supply Current vs. Temperature

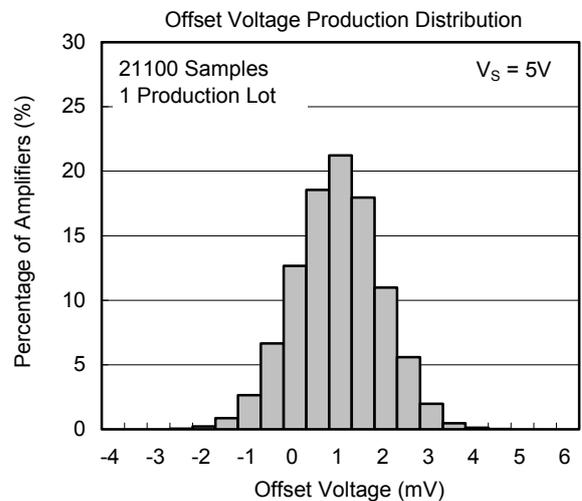
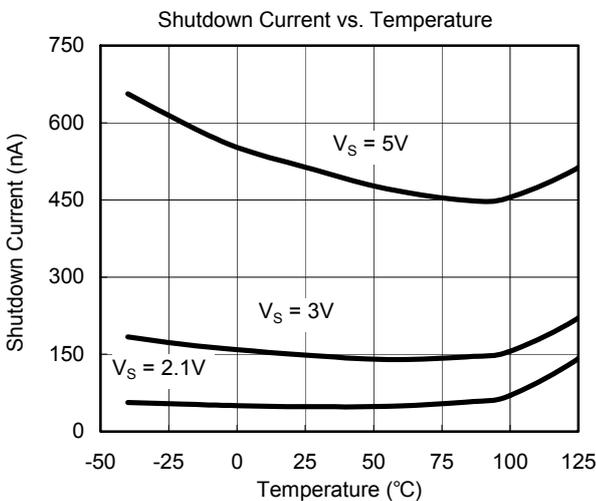
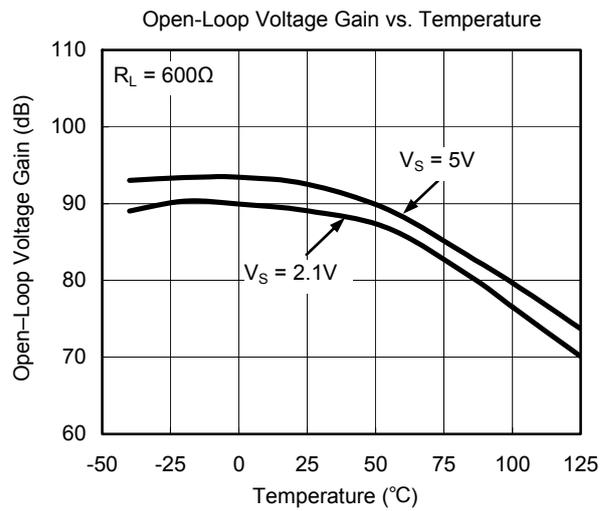
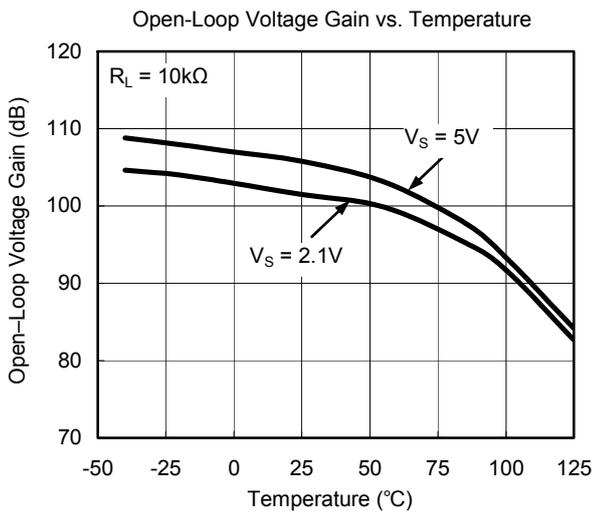
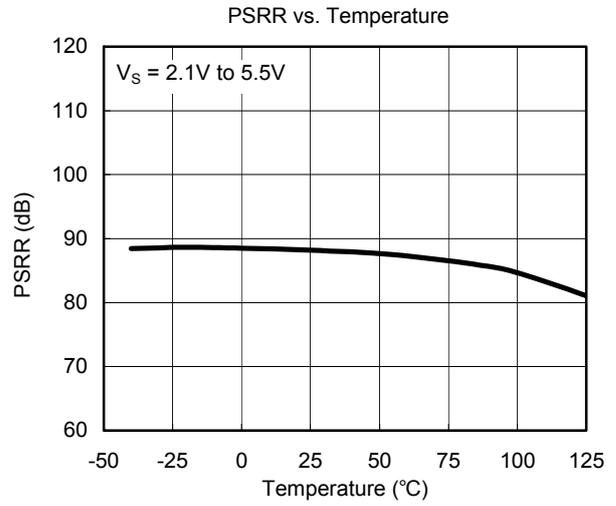
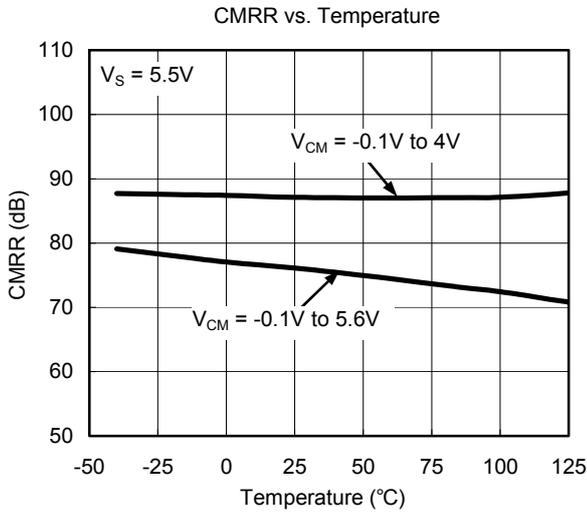


Input Voltage Noise Spectral Density vs. Frequency



**TYPICAL PERFORMANCE CHARACTERISTICS**

At  $T_A = +25^\circ\text{C}$ ,  $V_{CM} = V_S/2$ ,  $R_L = 600\Omega$ , unless otherwise noted.



APPLICATION INFORMATION

Driving Capacitive Loads

The SGM8603 can directly drive 4700pF in unity-gain without oscillation. The unity-gain follower (buffer) is the most sensitive configuration to capacitive loading. Direct capacitive loading reduces the phase margin of amplifiers and this results in ringing or even oscillation. Applications that require greater capacitive driving capability should use an isolation resistor between the output and the capacitive load like the circuit in Figure 1. The isolation resistor  $R_{ISO}$  and the load capacitor  $C_L$  form a zero to increase stability. The bigger the  $R_{ISO}$  resistor value, the more stable  $V_{OUT}$  will be. Note that this method results in a loss of gain accuracy because  $R_{ISO}$  forms a voltage divider with the  $R_{LOAD}$ .

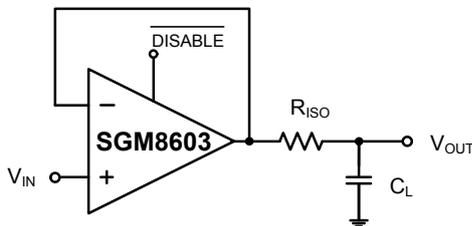


Figure 1. Indirectly Driving Heavy Capacitive Load

An improved circuit is shown Figure 2. It provides DC accuracy as well as AC stability.  $R_F$  provides the DC accuracy by connecting the inverting input with the output.  $C_F$  and  $R_{ISO}$  serve to counteract the loss of phase margin by feeding the high frequency component of the output signal back to the amplifier's inverting input, thereby preserving phase margin in the overall feedback loop.

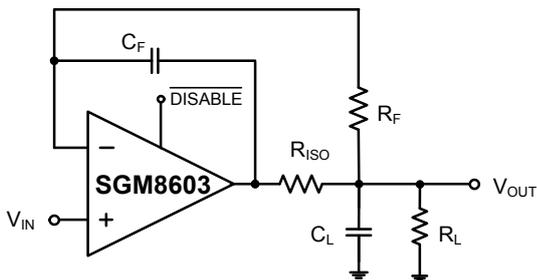


Figure 2. Indirectly Driving Heavy Capacitive Load with DC Accuracy

For non-buffer configuration, there are two other ways to increase the phase margin: (a) by increasing the amplifier's closed-loop gain or (b) by placing a capacitor in parallel with the feedback resistor to counteract the parasitic capacitance associated with inverting node.

Power-Supply Bypassing and Layout

The SGM8603 operates from either a single +2.1V to +5.5V supply or dual  $\pm 1.05V$  to  $\pm 2.75V$  supplies. For single-supply operation, bypass the power supply  $+V_S$  with a 0.1 $\mu F$  ceramic capacitor which should be placed close to the  $+V_S$  pin. For dual-supply operation, both the  $+V_S$  and the  $-V_S$  supplies should be bypassed to ground with separate 0.1 $\mu F$  ceramic capacitors. 2.2 $\mu F$  tantalum capacitor can be added for better performance.

Good PC board layout techniques optimize performance by decreasing the amount of stray capacitance at the op amp's inputs and output. To decrease stray capacitance, minimize trace lengths and widths by placing external components as close to the device as possible. Use surface-mount components whenever possible.

For the operational amplifier, soldering the part to the board directly is strongly recommended. Try to keep the high frequency current loop area small to minimize the EMI (electromagnetic interfacing).

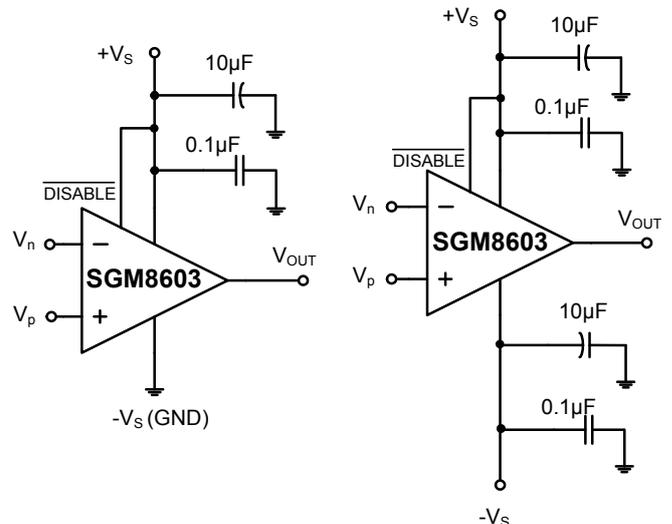


Figure 3. Amplifier with Bypass Capacitors

Grounding

A ground plane layer is important for SGM8603 circuit design. The length of the current path in an inductive ground return will create an unwanted voltage noise. Broad ground plane areas will reduce the parasitic inductance.

Input-to-Output Coupling

To minimize capacitive coupling, the input and output signal traces should not be in parallel. This helps reduce unwanted positive feedback.

**TYPICAL APPLICATION CIRCUITS**

**Differential Amplifier**

The circuit shown in Figure 4 performs the difference function. If the resistor ratios are equal ( $R_4/R_3 = R_2/R_1$ ), then  $V_{OUT} = (V_p - V_n) \times R_2/R_1 + V_{REF}$ .

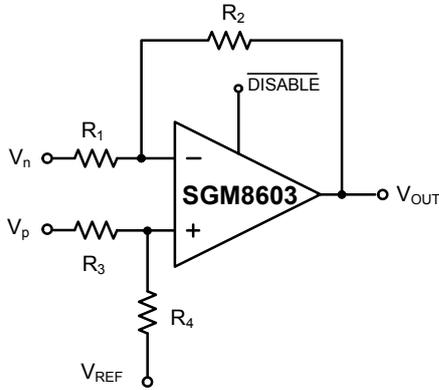


Figure 4. Differential Amplifier

**Instrumentation Amplifier**

The circuit in Figure 5 performs the same function as that in Figure 4 but with a high input impedance.

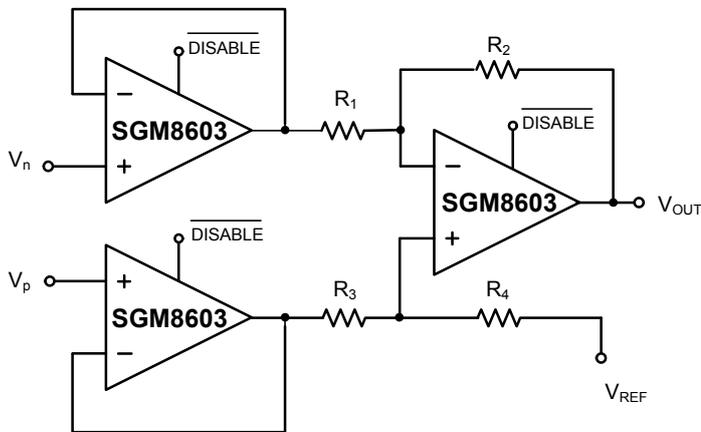


Figure 5. Instrumentation Amplifier

**Low-Pass Active Filter**

The low-pass filter shown in Figure 6 has a DC gain of  $(-R_2/R_1)$  and the  $-3\text{dB}$  corner frequency is  $1/2\pi R_2 C$ . Make sure the filter bandwidth is within the bandwidth of the amplifier. The large values of feedback resistors can couple with parasitic capacitance and cause undesired effects such as ringing or oscillation in high-speed amplifiers. Keep resistor values as low as possible and consistent with output loading consideration.

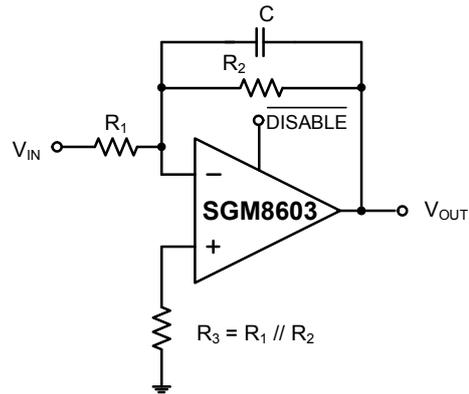
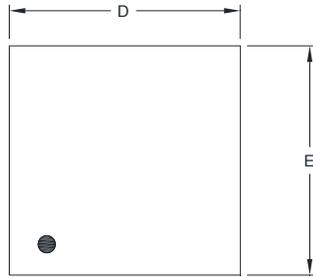


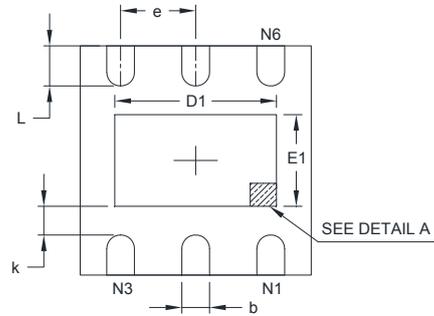
Figure 6. Low-Pass Active Filter

PACKAGE OUTLINE DIMENSIONS

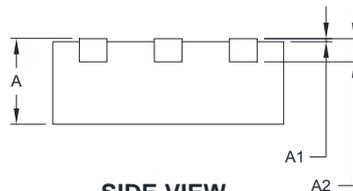
TDFN-2x2-6L



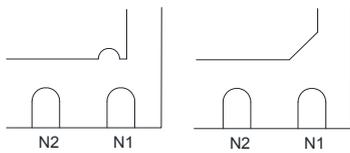
TOP VIEW



BOTTOM VIEW



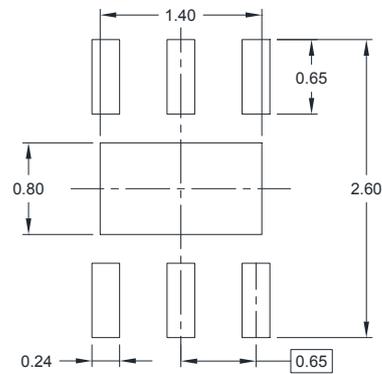
SIDE VIEW



DETAIL A

Pin #1 ID and Tie Bar Mark Options

NOTE: The configuration of the Pin #1 identifier is optional, but must be located within the zone indicated.

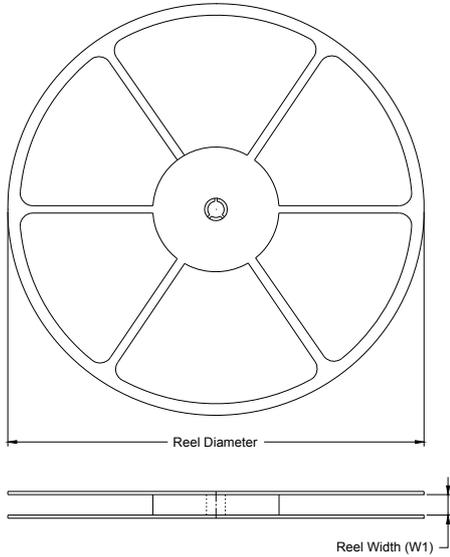


RECOMMENDED LAND PATTERN (Unit: mm)

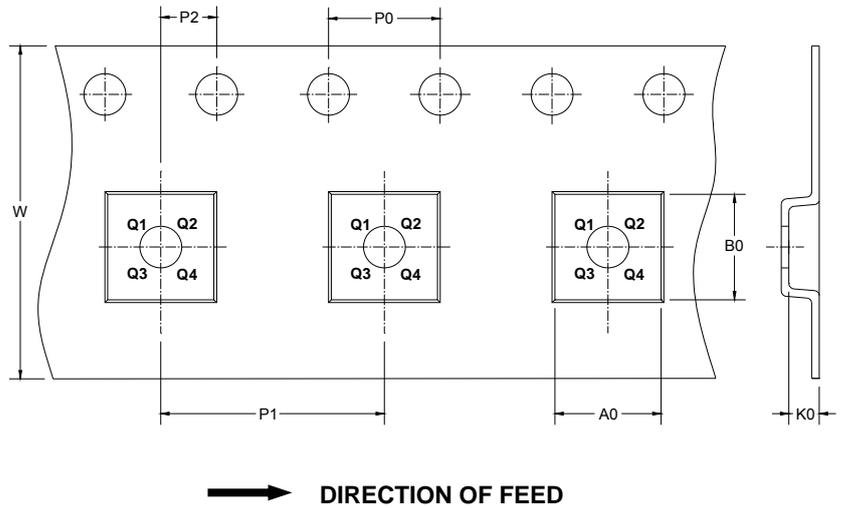
Symbol	Dimensions In Millimeters		Dimensions In Inches	
	MIN	MAX	MIN	MAX
A	0.700	0.800	0.028	0.031
A1	0.000	0.050	0.000	0.002
A2	0.203 REF		0.008 REF	
D	1.900	2.100	0.075	0.083
D1	1.100	1.450	0.043	0.057
E	1.900	2.100	0.075	0.083
E1	0.600	0.850	0.024	0.034
k	0.200 MIN		0.008 MIN	
b	0.180	0.300	0.007	0.012
e	0.650 TYP		0.026 TYP	
L	0.250	0.450	0.010	0.018

**TAPE AND REEL INFORMATION**

**REEL DIMENSIONS**



**TAPE DIMENSIONS**



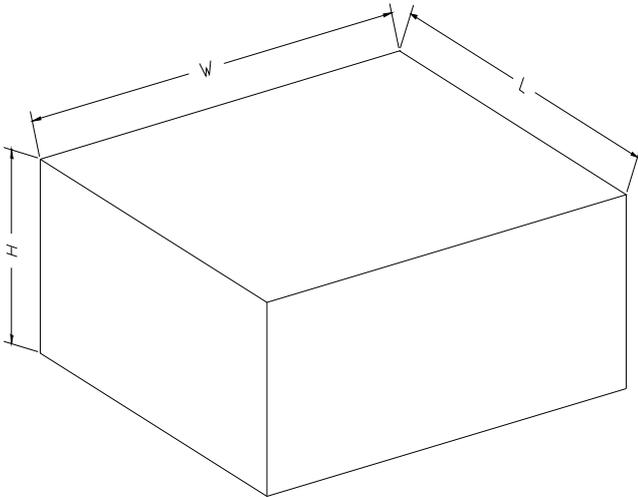
NOTE: The picture is only for reference. Please make the object as the standard.

**KEY PARAMETER LIST OF TAPE AND REEL**

Package Type	Reel Diameter	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P0 (mm)	P1 (mm)	P2 (mm)	W (mm)	Pin1 Quadrant
TDFN-2x2-6L	7"	9.5	2.30	2.30	1.10	4.00	4.00	2.00	8.00	Q1

DD0001

## CARTON BOX DIMENSIONS



NOTE: The picture is only for reference. Please make the object as the standard.

## KEY PARAMETER LIST OF CARTON BOX

Reel Type	Length (mm)	Width (mm)	Height (mm)	Pizza/Carton
7" (Option)	368	227	224	8
7"	442	410	224	18

DD0002